

Office of Science

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Fast detectors for polarimetry at the EIC

Forward QCD: open questions and future directions, KU - May 24, 2022

The **discrimination of background events** in High Energy Physics (HEP) experiments **is becoming more challenging**

For example, at the LHC:

[Detector upgrade at Run3 and HL-LHC](https://indico.cern.ch/event/783977/contributions/3467002/attachments/1893181/3123312/Malik_DMatLHC_DetectorUpgradeAtRun3andHL-LHC1.pdf)

Timing

$\mathcal{L}(t) = \frac{1}{\sigma} \frac{dN}{dt}$

Luminosity

Measures how efficiently the collider can produce collision events

Pile-UP

unwanted extra **collisions**, overlapping in the detectors

 $\mu(t)=\frac{\sigma \mathcal{L}(t)}{f n_b}$

Introduction to particle detectors

Timing

Minimization of the relative distance of closest approach:

 $|\Delta z$ (track, PV) | < average line density of events

Timing

Timing

The TOF can be used for particle ID

Precise Detector

- Timestamp of particle's passage with small uncertainties.
- Suited for **TOF**, **difference of time of arrival**, **time reference for HEP detectors**...
- Uncertainty can go as low as **σ ~ 10ps.**
- Timing measurement affect the spatial reconstruction accuracy $\sigma_i \propto \sigma_i$.

Fast Detectors

The precision of the timing measurement comes from a combination of factors…

$$
\sigma_t^2 = \sigma_{jitter}^2 + \sigma_{Time\ Walk}^2 + \sigma_{Local\ ionization}^2 + \sigma_{TDC}^2 + \sigma_{Distortion}^2
$$

Contributions are mitigated with the choice of a performing sensor

Contributions are mitigated with the choice of a read-out electronics

Fast Detectors

Fast detector

- Output a narrow pulse in response to the passage of a particle.
- Modern electronic components can be combined to develop circuit that outputs pulses as narrow as \sim few ns.
- A fast integration of the signal reduces the dead time of the detector: **single particle resolution can be achieved up to high rates**

- > short time integration
- > no energy calibration needed (for particle counting)

Fast Detectors

Chemical Vapor Deposition (sCVD) diamond

- > low dielectric constant (low capacitance)
- > high carriers mobility
- > incredibly low dark currents
- > The complicated production process limits the size to few mm³
- > intrinsically radiation hard

Low Gain Avalanche Diode (LGAD)

- > low gain(compared to APDs) → necessity to add an additional gain layer
- > fast rise time (dark currents' electron don't cause avalanche processes)
- > low dark currents
- $>$ the thickness is substantially reduced ($>$ 50 μ m)
- > Can be produced with Carbon insertion to reduce the radiation damages

Electrode

Silicon PhotoMultiplier (SiPM)

> Photo detection efficiency (PDE) ranges from 20 to 50% $>$ Gain $\sim 10^6$

> Low timing jitter

incident electron

escaping electron avalanche

- > not sensitive to external magnetic fields
- > Small dimensions and low voltages required for bias

Multi Channel Plate (MCP)

- > avalanche transit time ~100 ps range
- $\frac{\text{secondan}}{\text{electrons}} > \text{Gain} \sim 10^{4.1}10^{8}$
	- > fast rise time
	- > exceptionally low dark current < 0.5pA/cm2
	- > 0.4-3.0 mm thick plates
	- > up to ~1M channels/cm² of 5-15 m m diameter

Standard operation

CVD (Diamond) detectors

TOTEM - PPS diamond detectors

$$
\text{C} \quad \text{Low Dielectric constant} \ \ (\ C = \epsilon_0 \epsilon_d \frac{S}{d} = \frac{Q}{V} \)
$$

- ✓ High saturation velocity for electron and holes
- ✓ High Resistivity
	- × Really expensive: high purity required
	- × Smaller signal with respect to Silicons

The use of thin Silicon sensors provided of gain layer is becoming more common.

Why Thin?

> **Shorter drifting times** > Shorter integration time

 $>$ Planar Geometry with **side >> width** reduce the $\sigma_{Distortion}^2$

BUT

→ Landau fluctuations enhanced in thinner sensors

Also, **smaller drifting region → Smaller signals**

$$
\sigma_{jitter} \simeq 1.25 \frac{t_{rise}}{SNR} \Big|
$$

Fast Detectors

Low Gain Avalanche Detectors (LGAD)

 $>$ low gain(compared to APDs), G = 5 - 20

> fast rise time (dark currents' electron don't cause avalanche processes)

> low dark currents

 $>$ typical thickness \sim 50 μ m

> excellent radiation resistance

The beamline

Compton Electron Polarimetry

After every interaction @ the EIC, the level of polarization is verified using on-beam detectors.

Compton polarimeters represent one of the best option for measuring the polarization asymmetry of high energy particle beams.

Total Compton cross section (unpolarized + polarized)

$$
\frac{d\sigma}{d\rho}^{\pm} = \frac{d\sigma}{d\rho} \pm \frac{d\sigma}{d\rho}_p
$$

.. it displays an asymmetry with the helicity state

$$
\sigma(\vec{e} + \gamma \rightarrow e' + \gamma') \qquad \neq \qquad \sigma(\vec{e} + \gamma \rightarrow e' + \gamma')
$$

Theoretical longitudinal asymmetry

$$
\begin{cases}\nA_{QED}(\rho) = \frac{\sigma^+ - \sigma^-}{\sigma^+ + \sigma^-} \\
\rho = k'/k \approx \frac{4\gamma^2}{1 + \frac{4k\gamma}{m_e} + \theta_\gamma^2 \gamma^2}\n\end{cases}
$$

Compton Electron Polarimetry

- A powerful light source for producing the Fabri-Perot Cavity
- Magnetic apparatus to guide the electron beam to the cavity
- EM calorimeter for measuring the back-scattered photons energy
- A highly granular detector for collecting the scattered electrons

 $A_{EXP} \equiv$

Compton Electron Polarimetry

When inserted in the electron beamline:

Compton Electron Polarimetry

Compton-Compton-
scattered beam Main beam

Roman pots: detectors (kept in a secondary vacuum) moved to approach the beam to really close distance

Compton Electron Polarimetry

Hit distribution @ 5 GeV Analyzing power vs position @ 5 GeV

closest approach of the detector is defined by the 5 GeV configuration (~7mm)

Ciprian Gal - Compton IP location (V3)

Current technology

The electron detector

> set of four diamond planes each with 96 "microstrips" of metal alloy etched on the Surface. > Each strip is 0.180 mm wide separated by 0.02 mm.

The stack of multiple detectors offers 4 independent measurements and trigger options

A. Narayan et al. - Precision Electron-Beam Polarimetry at 1 GeV Using Diamond Microstrip Detectors

Current technology

$$
A_{EXP} = \frac{N^{+} - N^{-}}{N^{+} + N^{-}} = P_e * P_Y * A_{QED}(E_e, k_Y, k_{Y'})
$$

\n
$$
A_{EXP}^n = P_Y * P_e * A_{QED}^n(\rho)
$$

\n
$$
= \frac{N^{+}}{80}
$$

\n1000
\n1000
\n1010
\n1020
\n1030
\n
$$
A_{QED}^n(\rho)
$$

\n1001
\n1011
\n1020
\n1030
\n
$$
A_{QED}^n(\rho)
$$

\n10311
\n1041
\n1050
\n1070
\n1080
\n1091
\n10920
\n1011
\n10120
\n10120

A. Narayan et al. - Precision Electron-Beam Polarimetry at 1 GeV Using Diamond Microstrip Detectors

Current technology

Strip size optimized for **best occupancy** and **hit rate** AND reconstruction of the **analyzing power**

The technology proposed

Detector request:

Fast Response

- > Single particle counting for every bunch crossing per channel
- $>$ expected rate ~ 1 photons/bunch crossing \rightarrow 1/10ns ~ 100MHz
- > Sensor, amplifier, digitizer, DAQ to be designed

Aiming for 1% or better electron polarization accuracy (and 0.5 % for parity violation program)

The technology proposed

KU read-out board

- discrete components
- 8 identical two-stages transimpedance* amplifiers w/ adjustable gain
- adjustable input RC to adapt it to different solid state sensors
- control over integration time and time resolution
- 20 mm^2 x 20 mm^2 HV pad with stable bias up to ~ 500V

Increasing the input impedance, the signal becomes bigger but slower

Previous tests - single particle ID

Previous tests - single particle ID

LGAD operating as a single-quantum detector.

Typical pulse duration ~ 10 ns

if the **rate of incident particles < 200 MHz**: resolves single electrons with a time resolution of ~50 ps

On average, the algorithm fails when two particles pass through the detector within **6.5 ns** of each other

Probability of happening = $\exp(-6.5 \mu)$ μ = incident particle rate [GHz]

Fast detectors for polarimetry at the EIC New prototypes

We can do better!

> Optimization of the read-out for single particle ID > Reduction of the material budget behind the sensor's active area (for radiation transparency)

Use of thinner LGADS for MIPs:

- > Thickness ~150 um (tot)
- > linearity up to 10 MIPs, for high rates (>200MHz)
- > optimized for single particle ID

New prototypes

Using 90Sr electrons

New prototypes

Sacrificing some of the SNR the duration can be further reduced

Pulses 10 times shorter would improve by an order of magnitude the single-particle res. capabilities

New prototypes

The high electric field needed for the gain layer (3kV/cm), limits the minimum distance between pads:

Remember: the lateral dimensions of have to be much larger than thickness of substrate for a uniform multiplication field \rightarrow Large pads are preferred

Fill factor (active area/total area) << 100 %

New prototypes

AC-LGAD technology

> High-doped low-r n++ → large low-doped high-r n⁺ > thin insulator over n+, with fine-pitch electrodes

- New prototypes will need the design of optimized read-out for faster integration
	- Pulses 10 times shorter would improve by an order of magnitude the single-particle res. capabilities
- Thinner LGADs with optimized granularity provide better space and time resolution (AC-LGADs ?)
- For covering larger areas requires the development of dedicated ASICs
- This technology is of great appeal for polarimetry at the EIC, where, at the High lumi conditions, the polarization of the bunches have to be monitored every few ns.
- The promising radiation hardness of these sensors grants stable operation up to high absorbed fluences

Introduction to particle detectors

principles of detection

A particle detector works as a transductor, converting in useful information the energy lost by a charged particle passing through its active volume...

Generic particle detector principle of operation (solid state)

- 1. The energy lost by incident particles generates free charges moving through the sensor's active volume.
- 2. The read-out electronics shapes and amplifies the signals.
- 3. A fast, high-bandwidth sampler records and store the waveforms.

timing

When we talk about "Timing detectors" we usually refer to detecting devices optimized to accurately reconstruct particles times of arrival when collected from the sensor.

...When two particles cross the detector the TOF can be used for particle ID

Precise Detector

- Output the timestamp of a particle's passage in the active volume with a small uncertainty.
- Suited for **TOF**, **difference of time of arrival**, **time reference for HEP detectors**...
- In new generation detectors, the time uncertainty can go as low as **σ ~ 10ps.**
- The accuracy of the timing measurement affect the spatial reconstruction accuracy $\sigma_1 \propto \sigma_2$.

Introduction to particle detectors

sensors and properties

First step: choosing the sensor

$$
\sigma_{t}^{2} \sim \overset{\star}{\sigma}_{jitter}^{2} \overset{\star}{+} \overset{\star}{\sigma}_{Landau}^{2} + \overset{\star}{\sigma}_{TimeWalk}^{2} \overset{\star}{+} \overset{\star}{\sigma}_{Distorsion}^{2}
$$

Sensor's contributions:

*

Jitter = Variation in time caused by the noise of the system.

Landau = local stochastic fluctuations of the energy loss spatial distribution

The quality of the sensor, the production process, the material used … Decide the performance of the detector, drastically influencing properties such as:

- Charge Collection Efficiency (CCE)
- radiation tolerance
- gain due to multiplication processes

Solid state detectors are the most commonly used for timing

The polarization circuit connected to one of the electrodes, **provides the E-field** needed **to drift the** free **charges** inside the bulk, hence **generating the current collected by the read-out**

Solid state sensors

- **> 1000 (cm2/V)s** High **mobility** of the carriers
- *v***_s > 10⁷ cm/s High saturation velocity**
- **C_{sensor} ∝** $\varepsilon_{\textbf{0}}\varepsilon_{\textbf{d}}$ **(S/d)** the sensor capacitance is proportional to the dielectric constant (low capacitance means shorter integration time)
- The **Displacement energy** in sensors of new generation drastically improved (lifespan up to **10¹⁵ n_{eq})**
- **Low thickness** and **material budget.** Sensor size down to ~**50m**
- **High granularity** on the active area

Compton Electron Polarimetry

$$
A_{EXP} \equiv \frac{N^+ - N^-}{N^+ + N^-} = P_e * P_\gamma * A_{QED}(E_e, k_\gamma, k_{\gamma'})
$$

> Compton edge and zero needed to fit **P e** to **A measured = P e Atheory**

Fast Detectors

Low Gain Avalanche Detectors (LGAD) \bigcirc Production

Introduction to particle detectors

Front End and post-processing

$$
\sigma_{jitter} \simeq \frac{noise}{dV/dt} = 1.25 \frac{\tau_{0.1} - \tau_{0.9}}{SNR} = 1.25 \frac{t_{rise}}{SNR}
$$
 With $t_{rise} = \frac{0.35}{Bandwidth}$
Note (post-processing data):
Some of the contributions come from effects that are intrinsic to the nature of the measurement and can only be corrected during the analysis procedure.
The **Time Walk** is the mis-reconstruction of the timestamp of simultaneous pulses with **different amplitudes**.

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timing

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The CMS Mip Timing Layer

The CMS MTD - ETL & BTL

 \cdot 16624 sensors of 2x4 cm²

Precise detectors TOF and particle ID

The CMS Mip Timing Layer

The CMS MTD

Since 2017 US-CMS has been heavily involved in the design, test and characterization of the new generation timing detectors for the MTD project. In particular, the KU group collaborates with the R&D on the LGAD wafers needed for the End-Cap Timing Layer.

Sensor under test: W5 an W6 prototypes produced by the CNM and FBk companies

Carbon Interstitial defects filled with Carbon instead of with Boron and Gallium

Controlled annealing to re-activate the gain layer

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TOTEM and PPS Diamond detectors

TOTEM and PPS

During their technical upgrade the PPS and TOTEM collaboration decided to introduce timing detector in their experimental apparatus. The experiments, situated in the forward zones of the CMS barrel (~220 m on both sides) help closing the kinematics of pp diffractive and non-diffractive events and rejecting the pile-up expected for higher luminosity runs.

The ATLAS Forward Proton Detector (AFP) CMS Proton Precision Spectrometer

Quartic (Quartz bars + MCP readout)

•High fill factor (>85% per layer) •Despite the crosstalk resolution **< 25 ps** •requirement: spatial resolution of **2.12mm** •requirement: rate **5 MHz** per channel

ATLAS Forward Proton (AFP) time-of-flight (ToF) detector: construction & existing experience - T.Sykora

4 Layers of **sCVD Diamond detectors**

•Active area **~ 80 mm2**

•sustainable hit rate up to **few MHz/mm2** •double sCVD design **~ 50 ps** resolution (per plane)

•resolution degradation ~ 20-50% (full 2018 data taking) • stable time resolution in detecting 6–7 TeV protons

The CMS Precision Proton Spectrometer timing system: performance in Run 2, future upgrades and sensor radiation hardness studies - E.Bossini

TOTEM and PPS Diamond detectors

Design of a Double Layer Diamond Detector

During 2017 TOTEM experiment test beam campaign, the collaboration developed a new prototype based on two layers of diamond detectors mounted on the same read-out card.

The prototype has:

- Twice the signal amplitude
- Same charge collection time (same thickness)
- Same RMS noise (same preAmp)

 σ^2 $t \sim \sigma^2_{MCP} + \sigma^2_{DD} < 50 \text{ ps}$

The new detectors are now installed and operating in the main TOTEM and PPS apparatus during standard dedicated and CMS runs.

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Fast detectors for HEP and applications

Beam monitoring and dosimetry in medical facilities

Fast detectors for high rates

Many commercial (and research) applications require the use of fast detector for single particle resolution measurements. The ability to precisely count the number of incident particle per unit of time (without distortions due to long integration time or efficiency drop) represents an invaluable tool for evaluating **radiation doses, study beams luminosities, calculate the polarization of particle bunches**...

Example: monitor of a medical linac and characterization of the beam profile

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Charge ion Chamber [nC]

30

10

The test works as a proof of concepts for single particle resolution in new generation fast timing detectors (up to **tens of MHz** with the setup

The loss of efficiency due to multiple clustered event can be corrected with the post-processing

T.sidori, P. McCavana, B. McClean, R. McNulty, N. Minafra, N. Raab, L. Rock, C. Royon - DOI: 10.1088/1361-6560/ac0587